SPIE event printed pieces



Event overviews

Distributed onsite to all technical attendees, this piece reaches research and development professionals in different fields with news of your products and services. Most people will keep this piece in hand during the event, providing you with an opportunity to gain visibility.

Exhibition guides

Distributed at the event, this handy guide features exhibitor information and show floor locations. Increase your impact on your primary target audience with an ad in the colorful exhibition guide.



Reach thousands of potential customers who use SPIE event pieces to plan their agendas

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	URED EVENTS	LOCATION	CONFERENCE TOPICS	£57.	FVEN	EXHI	711.
SPIE	PHOTONICS WEST		Photonics West OPTO and LASE • Laser sources • Nonlinear optics and beam guiding • Micro/nano applications • Macro applications • Optoelectronic materials and devices • Photonic integration • Nanotechnologies in photonics • MOEMS-MEMS in photonics • Advanced quantum and optoelectronic applications • Semiconductor lasers and LEDs • Displays and holography • Optical communications: Devices to systems • 3D printing • Sustainability, Al/ML • Quantum		V	V	,
SPIE.	PHOTONICS WEST BIOS	San Francisco, California, USA	BiOS • Photonic therapeutics and diagnostics • Neurophotonics, neurosurgery, and optogenetics • Clinical technologies and systems • Tissue optics, laser-tissue interaction, and tissue engineering • Biomedical spectroscopy, microscopy, and imaging • Nano/biophotonics • BRAIN • Translational research • 3D printing • Net Zero, Al/ML • Quantum Biology	20,000			
SPIE	QUANTUM WEST		Quantum West • Quantum information systems • Quantum communications • Quantum computing and simulation • Quantum sensing, imaging, and timing systems • Enabling materials, devices, and techniques • Quantum Biology				
	ARIVRIMR	San Francisco, California, USA	3D computer vision/perception • display techniques/technologies/architectures • reconstruction • combiner optics/related architectures • human-machine interactions • human perception/immersive displays • light-field rendering • MEMS mirrors • display engines/imaging systems • optical sensors for 6DOF head tracking/SLAM-relocalization nanophotonics	3,000	~		
SPIE.	MEDICAL MAGING	San Diego, California, USA	Physics of medical imaging • Image processing • Computer-aided diagnosis • Image-guided procedures, robotic interventions, and modeling • Molecular, structural, and functional imaging • Image perception, and technology assessment • PACS-based imaging informatics • Ultrasonic imaging, tomography, and therapy • Digital pathology	1,000	~		
SPIE.	ADVANCED LITHOGRAPHY+ PATTERNING	San Jose, California, USA	Immersion • DFM/DPI • Nanofabrication and imprint • Resists • Etch • Lithography • Metrology • Inspection • DUV and EUV sources and optics • Process control • Patterning	2,000	~	~	
PRIL	SMART STRUCTURES+ NONDESTRUCTIVE EVALUATION	Long Beach, California, USA	Electroactive polymers • Smart structures and materials • Actuators and damping • Biomimetics • Energy harvesting • Embedded sensors • Sensor networks • Real-time NDE • Structural health monitoring • Fiber sensors	700	V		
DIE	OPTICAL SYSTEMS DESIGN	Strasbourg, France	Optical Design • Thin Films • Fabrication • Testing • Metrology • Illumination • Computational Optics • Instrument Technologies	400	~	~	
SPIE	PHOTONICS EUROPE	Strasbourg, France	Biophotonics • Micro/Nano technologies • Metamaterials • Photonic crystal fibers and devices • MEMS/MOEMS • Nanometrology • Optical sensors • Silicon photonics and photonic integrated circuits • Organic photonics • Solid-state lasers • Fiber lasers • Amplifiers • Photovoltaics • Photonics in automobiles • Image processing	1,900	V		
SPIE.	FUTURE SENSING TECHNOLOGIES	Yokohama, Japan	Quantum sensing • Cameras and imaging systems • AR/VR • Optical communications • Space-based missions • RADAR systems • Multi-band and hyperspectral imaging • LIDAR technology and applications • Polarization sensing and imaging • EO/IR/SWIR sensing and imaging • UAV applications • Autonomous vehicle sensing • Sensor-based sorting & quality control	125	<i>'</i>		
SPIE.	DEFENSE+ COMMERCIAL SENSING	National Harbor, Maryland, USA	Next generation sensor systems and applications • Advanced sensing and imaging • Imaging and analytics • Materials and devices • Big data • AI/ML • Autonomous systems • AR/VR/ XR • Cyber security • Advanced photon counting • IR Technology	3,500	~	~	
SPIE	ASTRONOMICAL TELESCOPES + INSTRUMENTATION	Yokohama, Japan	Optical, infrared, and millimeter wave and interferometry • Ultraviolet to gamma ray • Space and ground-based and airborne telescopes and instrumentation • Adaptive optics systems • Observatory operations • Modeling, systems engineering, and project management • Advances in optical and mechanical technologies • Millimeter, submillimeter, and far-infrared detectors and instrumentation • Software and cyberinfrastructure • High-energy, optical, and infrared detectors • Radio telescopes and telescopic arrays	2,500	~	~	
	OPTICS+ PHOTONICS	San Diego, California, USA	Advanced metrology • Remote sensing • Optical system design • Illumination engineering • Photovoltaics • Thin film coatings • Illumination systems • Solar concentrators • Plasmonics • Nanoengineered materials • Metamaterials • Nanocoatings • Nanomanufacturing • Organic photonics and electronics • Detectors and imaging • Photonic devices • OLEDs and LEDs • Lasers	3,000	V	~	
SPIE.		Edinburgh, United Kingdom	Remote Sensing • Atmospheric sensing • Platforms and systems • Environmental monitoring and applications • Earth surface sensing • Image and signal processing Security + Defence • Electro-optical sensing • Infrared systems • Optical materials and technologies • Sensors and networks • Millimetre wave and terahertz sensors • Biomaterials	900	~	~	
	PHOTOMASK TECHNOLOGY + EUV LITHOGRAPHY	Monterey, California, USA	Photomask • Design automation and data prep • Inverse lithography • Mask writing • Defects • Metrology • Inspection and repair • Maskless processes EUV Lithography • Sources and optics • Metrology and inspection • Mask and imaging • Pellicles • Resists • Process control and stochastics • Patterning and process enhancement • Extendibility • High-NA EUV	500	V		
	PHOTONEX	Manchester, United Kingdom	Quantum technologies • Photonics • Biophotonics • Lasers • Optical technologies • Materials analysis • Nanotechnology and thin film coatings • Vacuum equipment and in-vacuum technologies	1000	V	V	1
BD SPIE	LASER DAMAGE	TBD	Optical materials and measurements • Surfaces, mirrors and contamination • Thin films • Fundamental mechanisms • Laser-induced damage issues • Applications of laser damage • Properties modeling • Testing • Component fabrication	155	V		
SPIE. PHO	OTONICS A	China	High-power lasers • Semiconductor lasers • Optoelectronic devices and integration • Optical design and testing • Holography • Diffractive optics • Biomedical optics • Advanced sensor systems • Nanophotonics and micro/nano-optics • Plasmonics • Quantum and nonlinear optics	800	~		

SPIE PHOTONICS WEST/BIOS ADVERTISING

2024 insertion order

Contact SPIE Sales:

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For optics.org and SPIE Photonics West Show Daily advertising, contact:

Rob Fisher

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Dylan Byrne

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1 PLEASE PROVIDE COMPLETE BILLING INFORMATION

My company is an SPIE Corporate	Member □ No □ Yes Corporate ID#
Advertising company	
	State/Prov Zip
Contact	Title
Telephone	Fax
Email	□ Bill to advertising company (not ad agency)
Ad agency	
	State/Prov Zip
Contact	Title
Telephone	Fax
Email	P.O. (if required for billing)

2 SELECT ADVERTISEMENT ☐ Event overview or ☐ Exhibition guide Insertion order due 27 November 2023 Materials due 4 December 2023 Ad size Black and white 4-color Full page □ \$1,295 □ \$2,830 2/3 Page □ \$997 □ \$2,475 1/2 Page vertical □ \$860 □ \$2,326 1/2 Page horizontal □ \$860 □ \$2,326 □ \$653 1/3 Page □ \$2,085 1/4 Page □ \$516 □ \$1,959 **Special position** 4-color Cover 2 - inside front □ \$4,308 Cover 3 - inside back □ \$4,148 Cover 4 - back cover □ \$4,778 Page 3 □ \$3,885 Page 5 □ \$3,885 Page 7 □ \$3,885 Other righthand forward pages available upon request.

SEE NEXT PAGE FOR:

- MECHANICAL REQUIREMENTS
- ELECTRONIC FILE REQUIREMENTS
- AD SUBMISSION GUIDELINES
- POLICIES

Ordered by	Title
Authorizing signature	
4 PAYMENT INFORMATION	Billed after publication prints. Please check one of the following options.
☐ Check/money order enclosed (pages)	yable to SPIE)
□ Credit card SPIE accepts VISA, MasterCard, America	an Express, Diners Club, and Discover cards
☐ Wire transfer	= \$
☐ Please send invoice upon receipt o	of this contract.

33543

SPIE PHOTONICS WEST/BIOS ADVERTISING

2024 insertion order

MECHANICAL REQUIREMENTS

TRIM size - Program will be cut to this size.

BLEED size - Background images need to be slightly larger than trim so it looks like it goes off the edge.

LIVE area - Keep all text and important elements inside live area so they do not get cut off when program is bound and trimmed after printing.

IMPORTANT:

PLEASE REMOVE ALL PRINTER MARKS INCLUDING REGISTRATION AND CROP MARKS FROM YOUR AD FILE

Technical program or exhibition guide					
Ad size	Inches	Millimeters			
Full page					
Trim size	$8^{3}/_{8} \times 10^{3}/_{4}$	213 × 273			
Bleed	$8^{3}/_{4} \times 11^{1}/_{8}$	222 × 283			
Live area	7 × 10	178 × 254			
2/3 Page	$4^{9}/_{16} \times 10$	116 × 254			
1/2 Page vertical	$3^{5}/_{16} \times 10$	84 × 254			
1/2 Page horizontal	$7 \times 4^{7}/_{8}$	178 × 124			
1/3 Page vertical	$2^{3}/_{16} \times 10$	56 × 254			
1/4 Page	$3^{5}/_{16} \times 4^{7}/_{8}$	84 × 124			

Special	position

Cover 2 - inside front*	
Cover 3 - inside back*	
Cover 4 - back cover*	*see full-page ad specs above
Page 3*	
Page 5*	

Other righthand forward pages available upon request.

ELECTRONIC FILE REQUIREMENTS

AD SHOULD BE FURNISHED AS A HIGH-RESOLUTION PDF (at least 300 dpi). Fonts must be embedded, outlined, or included. All
colors should be CMYK builds. Note: eps, jpg, and tif files will be accepted but PDF IS PREFERRED.

Page 7*

- Keep essential matter of an ad (text or image) inside the live area or 1/4" inside TRIM.
- PLEASE REMOVE ALL PRINTER MARKS INCLUDING REGISTRATION AND CROP MARKS FROM YOUR AD FILE.

AD MATERIAL SUBMISSION GUIDELINES

- Ads can be emailed (files <5 MB may be emailed to advertising@spie.org).
- Please contact advertising@spie.org with questions about ad submissions.

POLICIES

- · Changes or modifications to submitted ad materials may be subject to production charges.
- SPIE does not guarantee reproduction quality for late ads or ads that do not meet the mechanical and electronic file requirements.
- Ad materials are stored for 12 months, unless other arrangements have been made in writing.
- · No refunds on ads cancelled after insertion order due dates.
- No guaranteed ad placement other than accepted special cover positions.
- SPIE reserves the right to cancel or reject any advertisement; this includes solicitation by organizations for membership and event attendees, authors or exhibitors, or products unrelated to the event.
- · Simulation of the publication's format is not permitted.
- · SPIE reserves the right to place the word "advertisement" with copy that, in the publisher's opinion, resembles editorial matter.
- All advertising is subject to publisher's approval and agreement by the advertiser and agency to indemnify and protect the publisher
 from and against any claims, loss, liability, or expense, including reasonable attorney's fees, arising out of publication of such
 advertisement.
- Ads received after the materials due dates are subject to a 10% surcharge.
- Recognized ad agencies will receive a 15% commission. Commissions given to ad agencies will be forfeited if payment is not received within 60 days of invoice date.
- · Account delinquency may affect advertiser's and agency's ability to book space in future issues.
- For accounts with more than one unpaid invoice, all cash received will be paid to oldest invoice first.
- Advertiser and agency agree to pay all collection costs that result from our collection efforts on delinquent balances, including reasonable attorney's fees.

LIABILITY

The publisher reserves the right to hold the advertiser and advertising agency jointly and severally liable to SPIE for payments due hereunder. The advertiser is at all times liable for payment of all account balances due and all other liabilities and deemed to receive refund payments, adjustments, notices and all other documents when the same are delivered to their advertising agency. Payments by the advertiser to the advertising agency for services does not constitute payment to SPIE. Any language to the contrary in any advertising agency's insertion orders or other documents is void and without effect.

BILLING AND DISCOUNTS

- Billing and tear sheets will be mailed after the piece has been published. Payment must be made to SPIE within 30 days of invoice date. After 30 days, a 5% late fee will be added to all unpaid balances.
- · Multiple ad placements per event receive a 10% discount for each additional ad.
- · SPIE Corporate Members receive a 15% discount on published rates.